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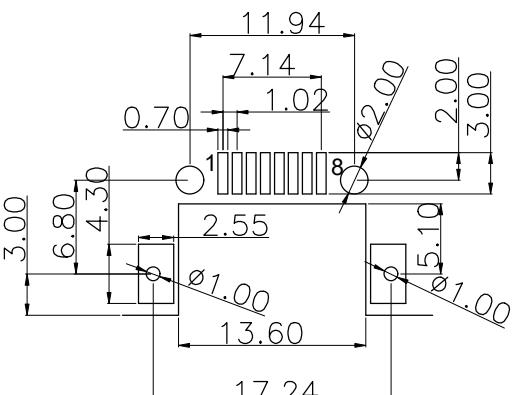
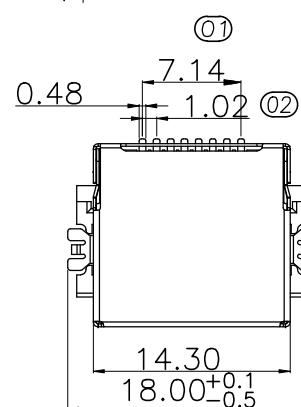
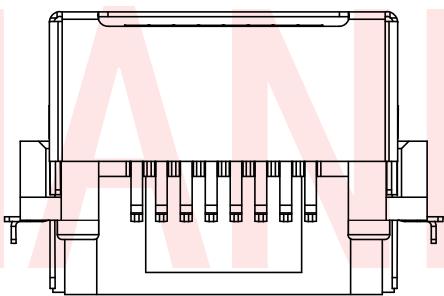
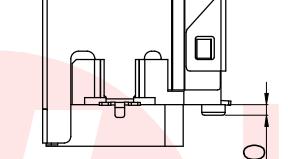
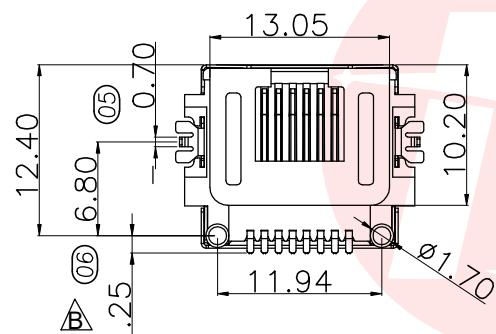
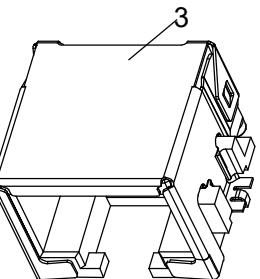
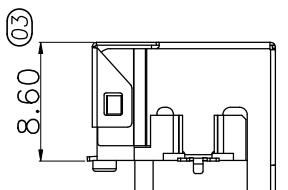
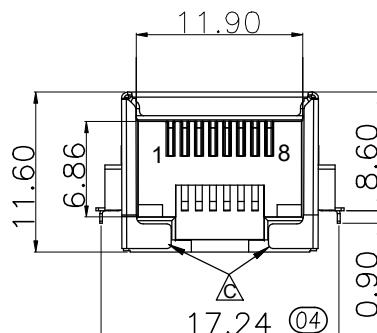
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RoHS
Compliant
2011/65/EU



PCBLAYOUT TOP VIEW
TOL ±0.05

REV.

ECN NO OR DESCRIPTION

REVISED

DATE

NOTES

MATERIAL

- 1.HOUSING MATERIAL: THERMO PLASTICS UL94V-0.
- 2.CONTACT MATERIAL: PHOSPHOR BRONZE T=0.3mm.
- 3.PLATING:GOLD PLATIN ON CONTAC AREA,
TIN PLATING ON SOLER AREA,
NICKEL PLATING ALL OVER.
- 4.SHIELD:0.20mm THICKNESS COPPER ALLOY
WITH NICKEL PLATED.

ELECTRICAL

- 1.VOLTAGE RATING:125 VAC RMS.
- 2.CURRENT RATING:1.5 AMP.
- 3.CONTRACT RESISTANCE:40 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE:500 MEGOHMS MIN @ 100V DC .
- 5.DIELECTRIC DIELECTRIC
RESISTANCE:500V DC RMS 50Hz. 1MIN.

MECHANICAL

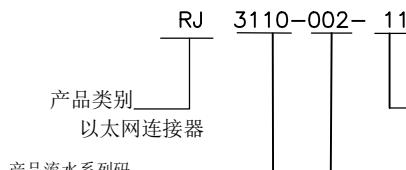
- 1.DURRABILITY:750 CYCLES MIN.
2. MATING/UNMATING FORC: 2.24 KG.F MAX.

ENVIRONMENTAL:

- 1.OPERATION: -40°C~+85°C.
- 2.STORAGE: -40°C~+85°C.

8	/
7	/
6	RX-
5	/
4	/
3	RX+
2	TX-
1	TX+

PIN序说明



11:GF LCP 黑盘装
21:GF LCP 黑卷装
002:8.6全包铜壳

UNLESS OTHERWISE
SPECIFIED TOLERANCES



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

DECIMALS: X :±0.30 X.X :±0.20 X.XX :±0.10
ANGLES: X :±2° X.X :±1°
DWN: xiong CHKD: lee APVD: wang

TITLE: RJ45沉板8.6 SMT 全包GF LCP 黑
PART NO. RJ3110-002-11
SCALE:1:1 UNIT: mm
SIZE: A4 SHEET:1OF 1 REV: A4
CUSTOMER COPY